## 2SK2206

Silicon N-Channel MOS FET

# HITACHI

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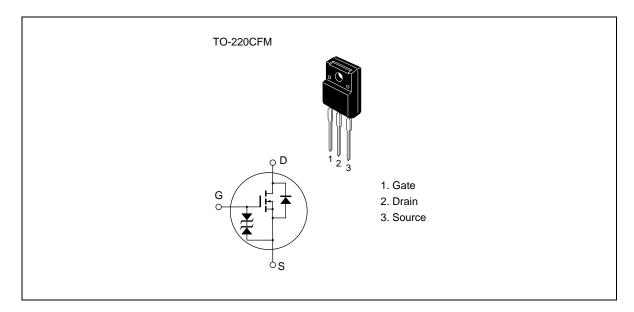
#### Application

High speed power switching

#### Features

- Low on-resistance
- Low drive current
- High speed switching
- 4 V gate drive device can be driven from 5 V source
- Suitable for DC-DC converter, Motor control

#### Outline



### 2SK2206

### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	30	V
Gate to source voltage	V <sub>gss</sub>	±20	V
Drain current	I <sub>D</sub>	45	А
Drain peak current	ا <sub>D</sub> *1	180	А
Body to drain diode reverse drain current	l <sub>dr</sub>	45	А
Channel dissipation	Pch* <sup>2</sup>	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1.  $PW \le 10 \ \mu s$ , duty cycle  $\le 1 \ \%$ 

2. Value at Tc = 25 °C

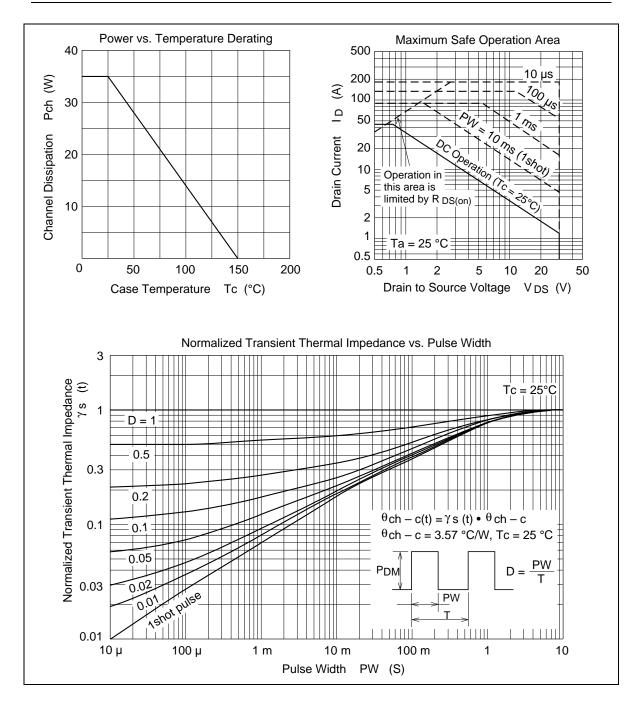
### **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\scriptscriptstyle (BR)DSS}$	30		_	V	$I_{_{\rm D}}$ = 10 mA, $V_{_{\rm GS}}$ = 0
Gate to source breakdown voltage	$V_{\scriptscriptstyle (BR)GSS}$	±20		_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—		±10	μA	$V_{_{\rm GS}} = \pm 16$ V, $V_{_{\rm DS}} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—		250	μA	$V_{_{DS}} = 25 \text{ V}, \text{ V}_{_{GS}} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	1.0		2.5	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$\boldsymbol{R}_{DS(on)}$	_	0.011	0.015	Ω	$I_{_{\rm D}} = 25 \text{ A}$ $V_{_{\rm GS}} = 10 \text{ V}^{*1}$
		—	0.016	0.022	Ω	$I_{\rm D} = 25 \text{ A}$ $V_{\rm GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	y <sub>fs</sub>	23	38	—	S	$I_{\rm D} = 25 \text{ A}$ $V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	—	3600	_	рF	$V_{DS} = 10 V$ $V_{GS} = 0$ f = 1 MHz
Output capacitance	Coss	_	2000	_	pF	
Reverse transfer capacitance	Crss	_	400		pF	
Turn-on delay time	t <sub>d(on)</sub>	_	30	_	ns	$I_{D} = 25 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_{L} = 1.2 \Omega$
Rise time	t,	—	230	_	ns	
Turn-off delay time	$\mathbf{t}_{d(off)}$	_	435	_	ns	
Fall time	t,	_	360	_	ns	
Body to drain diode forward voltage	$V_{dF}$	—	1.1	—	V	$I_{_{\rm F}} = 45$ A, $V_{_{\rm GS}} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	75	—	ns	$I_{_{\rm F}}$ = 45 A, $V_{_{\rm GS}}$ = 0, diF / dt = 50 A / µs
Note 1. Pulse Test						

Note 1. Pulse Test

See characteristic curve of 2SK2204.

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